

5.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

Guard Ring Die Construction for Transient Protection

Ideally Suited for Automatic Assembly

Low Power Loss, High Efficiency

Surge Overload Rating to 175A Peak

For Use in Low Voltage, High Frequency Inverters, Free

Wheeling, and Polarity Protection Application

Lead Free Finish/RoHS Compliant (Note 3)

Mechanical Data

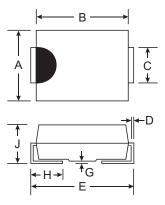
Case: SMC

Case Material: Molded Plastic. UL Flammability

Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3) Polarity: Cathode Band or Cathode Notch

Marking Information: See Page 3 Ordering Information: See Page 3 Weight: 0.21 grams (approximate)



SMC						
Dim	Min	Max				
Α	5.59	6.22				
В	6.60	7.11				
С	2.75	3.18				
D	0.15	0.31				
E	7.75	8.13				
G	0.10	0.20				
Н	0.76	1.52				
J	2.00	2.62				
All Dimensions in mm						

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

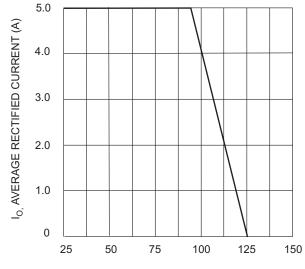
Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	B520C	B530C	B540C	B550C	B560C	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage		V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current	@ T _T = 90°C	lo	5.0			Α		
Non-Repetitive Peak Forward Surge C half-sine-wave Superimposed on Rate	urrent, 8.3 ms single d Load	I _{FSM}	175			Α		
Forward Voltage	@ $I_F = 5.0A DC$	V_{FM}	0.55 0.70		70	V		
Peak Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 100°C	I _{RM}	0.5 20				mA	
Typical Total Capacitance (Note 2)		Ст	300				pF	
Thermal Resistance, Junction to Terminal		R _{JT}	10				°C/W	
Thermal Resistance, Junction to Ambient (Note 1)		R JA	50				°C/W	
Operating Temperature Range		Tj	-55 to +125				°C	
Storage Temperature Range		T _{STG}	-55 to +150				°C	

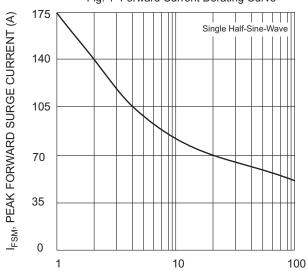
Notes:

- 1. Thermal Resistance: Junction to ambient, unit mounted on PC board with 8.0 mm2 (0.033 mm thick) copper pads as heat sink.
- 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
- 3. RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see EU Directive Annex Note 7.

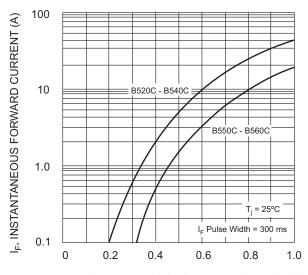




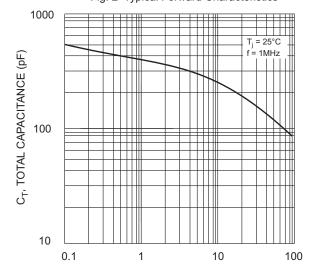
T_T, TERMINAL TEMPERATURE (°C) Fig. 1 Forward Current Derating Curve



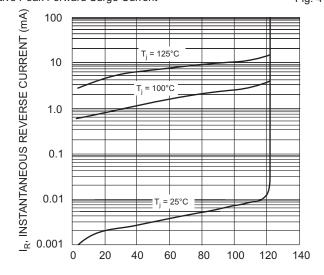
NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Forward Surge Current



V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics



V_R, DC REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 5 Typical Reverse Characteristics



Ordering Information (Note 4)

Device	Packaging	Shipping
B520C-13-F	SMC	3000/Tape & Reel
B530C-13-F	SMC	3000/Tape & Reel
B540C-13-F	SMC	3000/Tape & Reel
B550C-13-F	SMC	3000/Tape & Reel
B560C-13-F	SMC	3000/Tape & Reel

Notes:

4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



B5x0C = Product type marking code, ex: B540C (SMC package)

Dil = Manufacturers' code marking

YWW = Date code marking

Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52

x = 2,3,4,5 or 6 - i.e., x = 4 for B540C

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